



## Digital Signature and Cryptography: Latest Advances and Prospects

Guest Editor:

**Dr. Hiroyuki Sato**

Information Technology Center,  
The University of Tokyo, Tokyo  
113-0032, Japan

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### Message from the Guest Editor

Dear Colleagues,

Today, digital signatures, as a major and successful application of cryptography, play an essential role in business processes representing the intention of signers. We now see a number of enterprise applications and products that leverage digital signatures in a workflow. Multi-signatures, group signatures, and BBS+ signatures are now within the scope of deployment to handle complicated workflows and business scenarios. Furthermore, in terms of integrity, digital signature technology is fundamental in guaranteeing the integrity of blockchains. Verifiable credentials essentially use digital signatures to claim their integrity. Digital signatures are now studied to extend to apply to new application fields and new cryptography, including lattice cryptography. In this Special Issue, reflecting this growing significance of digital signatures in theory and application scenarios, papers discussing latest advances and prospects of digital signatures in theory and applications are called for.





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**Prof. Dr. Giulio Nicola Cerullo**

Dipartimento di Fisica,  
Politecnico di Milano, Piazza L.  
da Vinci 32, 20133 Milano, Italy

## Message from the Editor-in-Chief

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Applied Sciences Editorial Office  
MDPI, St. Alban-Anlage 66  
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